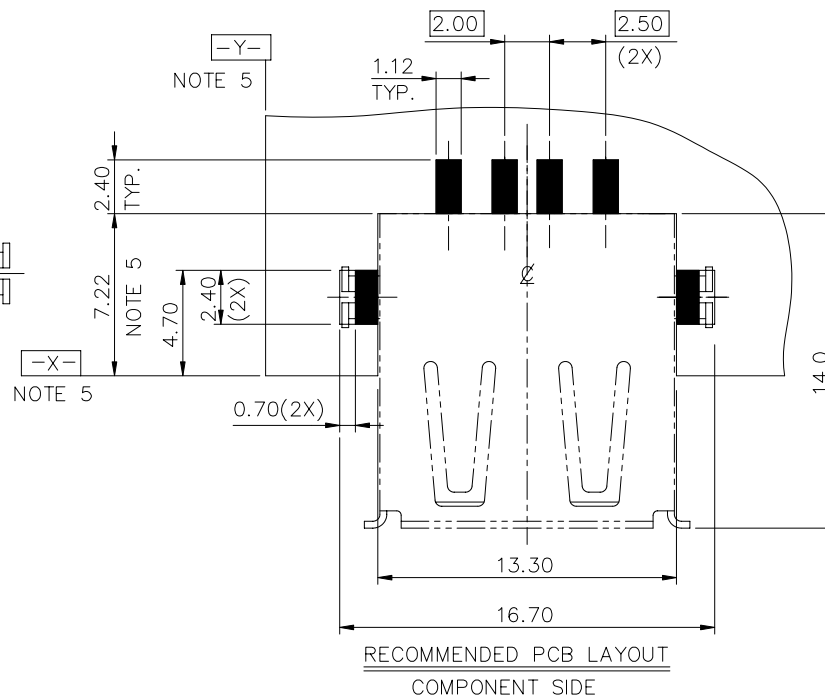
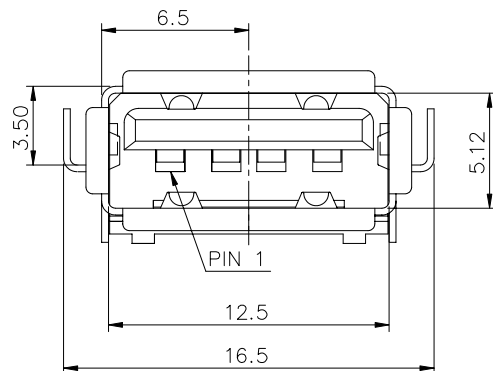
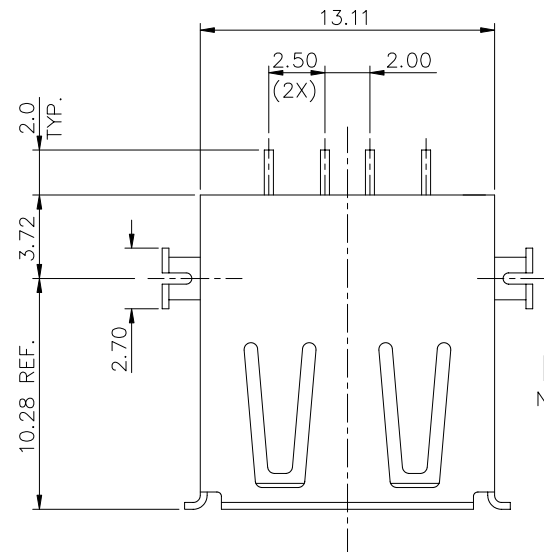


NOTES:

- 1.RECOMMENDED PCB THICKNESS SEE PRODUCT NO CODE.
- 2.MATERIAL:
HOUSING: THERMOPLASTIC, UL94 V-0 RATED.
TERMINAL: COPPER ALLOY.
SHIELD: COPPER ALLOY.
- 3.PLATING:
CONTACTS: SEE NOTE 6.
SHIELD: 30u" MIN. NICKEL PLATING.
- 4.2.67mm MAXIMUM PANEL THICKNESS IF MOUNTED
BEHIND PANEL.
- 5.DATUM AND BASIC DIM. ESTABLISHED BY CUSTOMER.
- 6.PART NO. DESCRIPTION:

52369-X X 1 X LF
LEAD FREE OPTION
TERMINAL PLATING OPTION:
0 - 30u" GXT CONTACT AREA
2 - 30u" GOLD CONTACT AREA
1 PCB T =1.0mm
2 PCB T =1.6mm
HOUSING OPTIONS:
0 - WHITE
1 - BLACK

NOW FCI AVAILABLE P/N'S FOLLOWED:

52369-0110/0110LF
52369-0112/0112LF
52369-1110/1110LF
52369-1112/1112LF
52369-1212/1212LF
52369-0212/0212LF

7. P/N'S WITH SUFFIX "LF" ARE LEAD FREE P/N'S
8. PACKING STANDARD GS-14-920 WILL BE APPLIED
FOR LEAD FREE P/N'S
9. FOR LEAD FREE P/N, THE PRODUCT MEET
EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY
REGULATION AS DESCRIBED IN GS-22-008
- 10.FOR LEAD FREE P/N, THE HOUSING WILL
WITHSTAND EXPOSURE TO 260°C PEAK
TERMERATURE FOR 40 SECONDS IN A
CONVECTION, INFRO-RED OR VAPOR PHASE
REFLOW OVEN.

mat'l code				tolerance unless otherwise specified		CUSTOMER COPY	FCI www.fciconnect.com		
rev.	ecn no.	dr	date	linear	.0 ± 0.30	projection 	title USB SMT NO SCREW SHIELD ASS'Y		
A	T90367	MW	10/26/99		.00 ± 0.20				
B	T00117	PP	04/18/00		.000± 0.10				
C	T10001	PP	01/02/01	angles	± 2°	mm/inch scale 4 : 1	product family USB code TWN size dwg no. 52369 sheet 1 OF 1		
D	N05-0078	PH	03/21/05	dr	MAGGIE WU06/17/99				
				enrg	GARY TANG06/17/99				
				chr	GARY TANG06/17/99				
				appd	JENN TSAO06/17/99				
sheet index	revision	D							